



**■ SMART
PHOTONICS**

Bringing your innovation to life

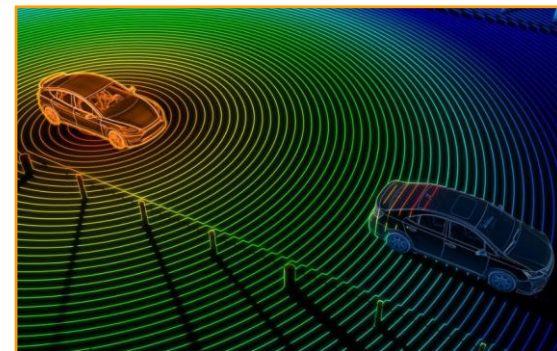


CAN A PDK-BASED INP FOUNDRY RESPOND TO CURRENT MARKET TRENDS?

January 2024

MEGATRENDS AND PIC RELATED TECHNOLOGIES

- Artificial Intelligence
 - Driving force to increase bandwidth
- Network Security
 - Quantum Key Distribution
- Autonomous Driving
 - LiDAR



COMPLEXITY FROM NETWORK TO OPTICS

- Coherent technology is needed at all distances
- Increasing speed, power budgets
- Addressing Power, Cost, and Form-factor
- Enables entering emerging markets for coherent down to 2km

PICs come to the rescue!



PICS: POWER, COST, AND FORM-FACTOR

- Enable complex systems
- All required functionalities on a single chip
 - Integrated lasers, amplifiers
 - High speed (IQ) modulators
 - No optical connection losses
- Scale and cost down
 - Yield following semiconductor electronics legacy
 - Lower assembly cost



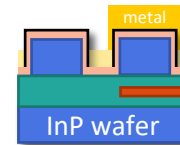
PHOTONIC INTEGRATION PARALLELS ELECTRONICS

1 Integration drives new applications



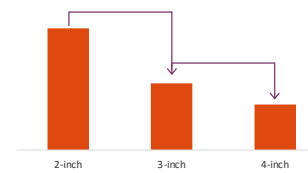
2 Semiconductor manufacturing process

Planar process and tool overlap



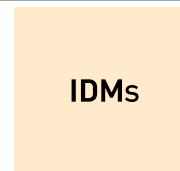
3 Economies of scale

Cost reduction drives adoption

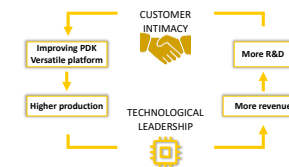


4 Industry structure

Specialization within value chain

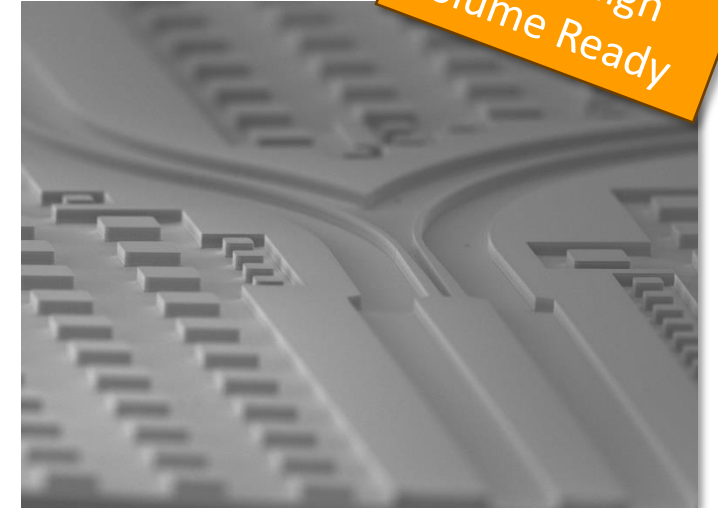


5 Foundry Technology/Customer flywheel



INTRODUCTION SMART PHOTONICS

InP PIC Production Line and PDK



4 inch – High Volume Ready

- Open Foundry – manufacturing services for InP wafers based on customers' designs
- Processes and capacity for supporting customers from prototype to volume

✓ **Volume Production**

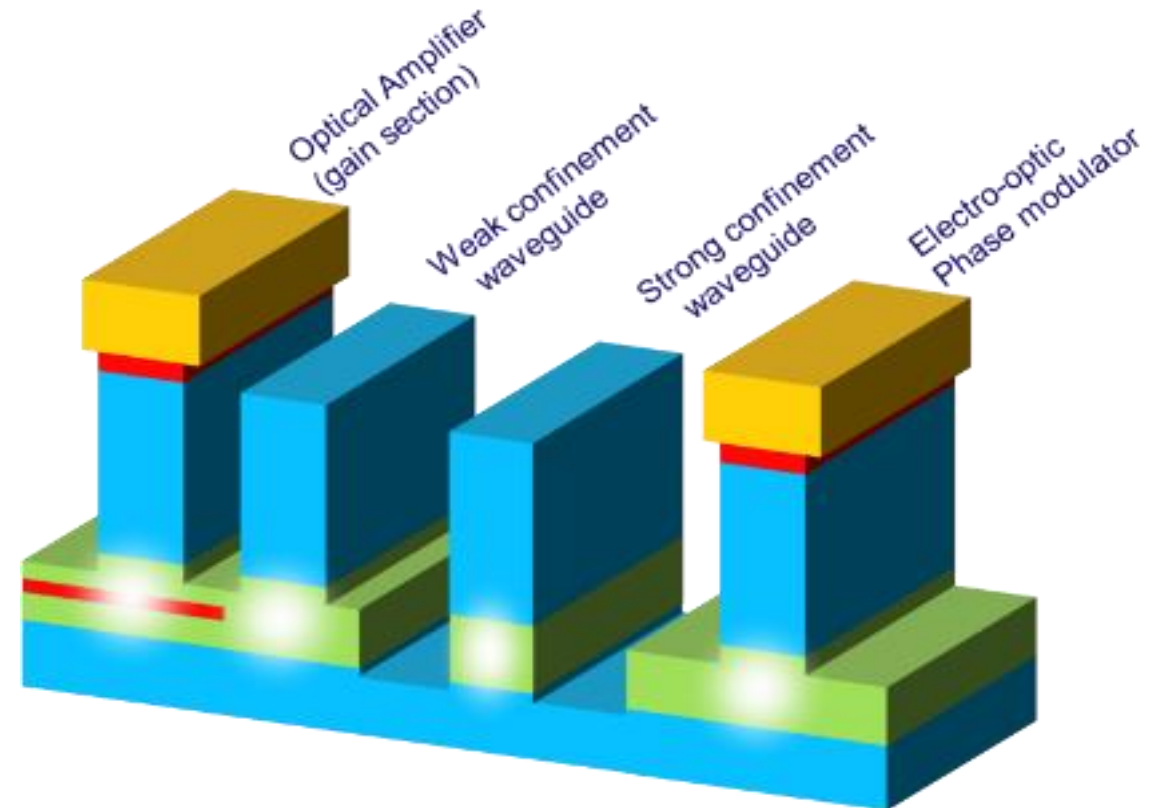
✓ **Validated PDKs**

✓ **EU based**



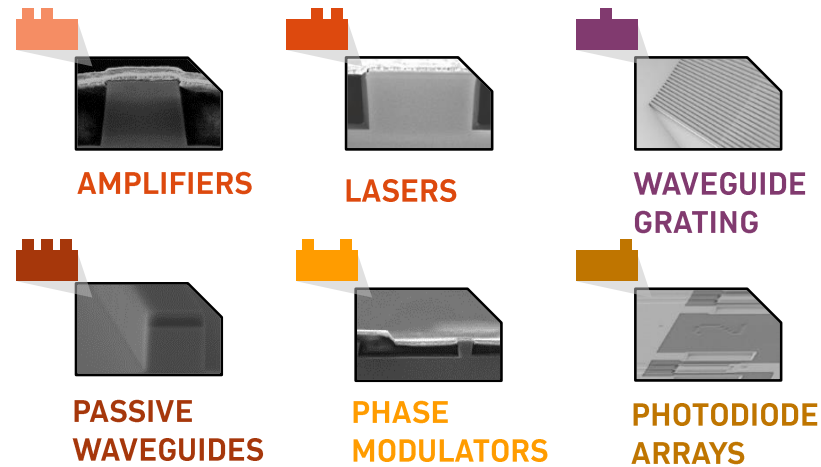
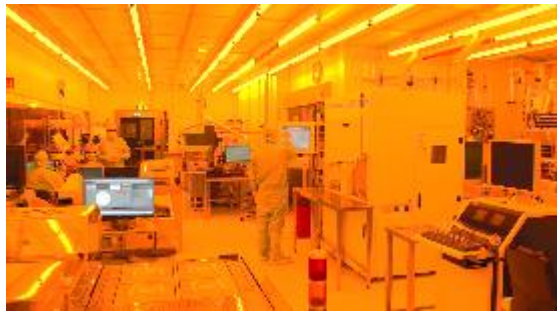
InP IS KEY TO HIGH LEVEL INTEGRATION

- Only material suited for lasers and amplifiers
 - Monolithic integration, no compromise between active and passive
 - High performance modulators
 - Full on-wafer electrical testing
-
- High level integration on InP drives down system costs!

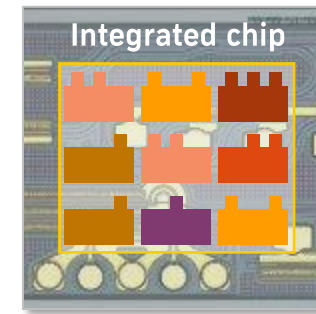


SIMPLIFYING DESIGN COMPLEXITY: PDK

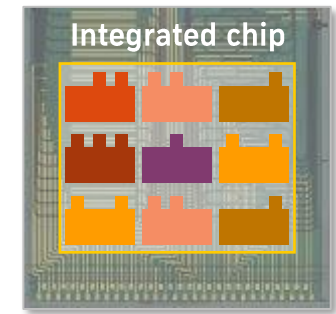
PROCESS DESIGN KIT: TOOLBOX



DATACOM CHIPS



SENSING CHIPS



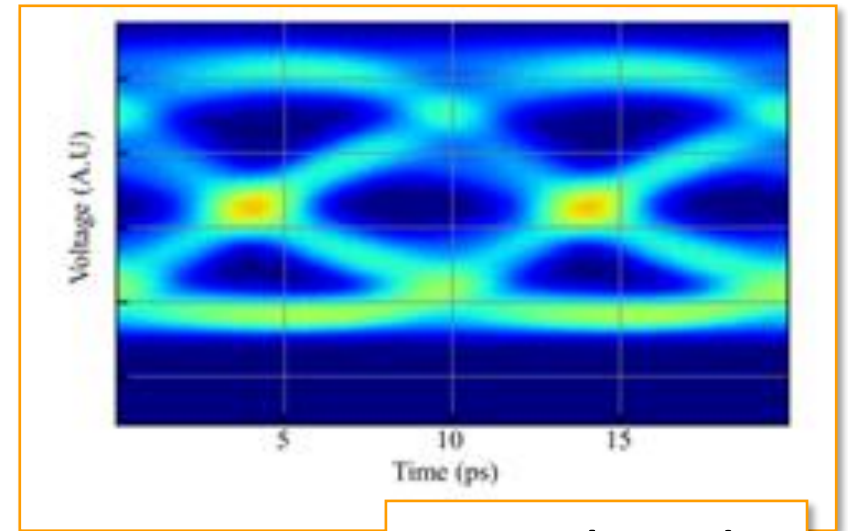
- Proven reliability and performance
- Leverage experience

- Leverage infrastructure
- Reduce time to market

Specific PDKs for C-band and O-band

MODULATOR

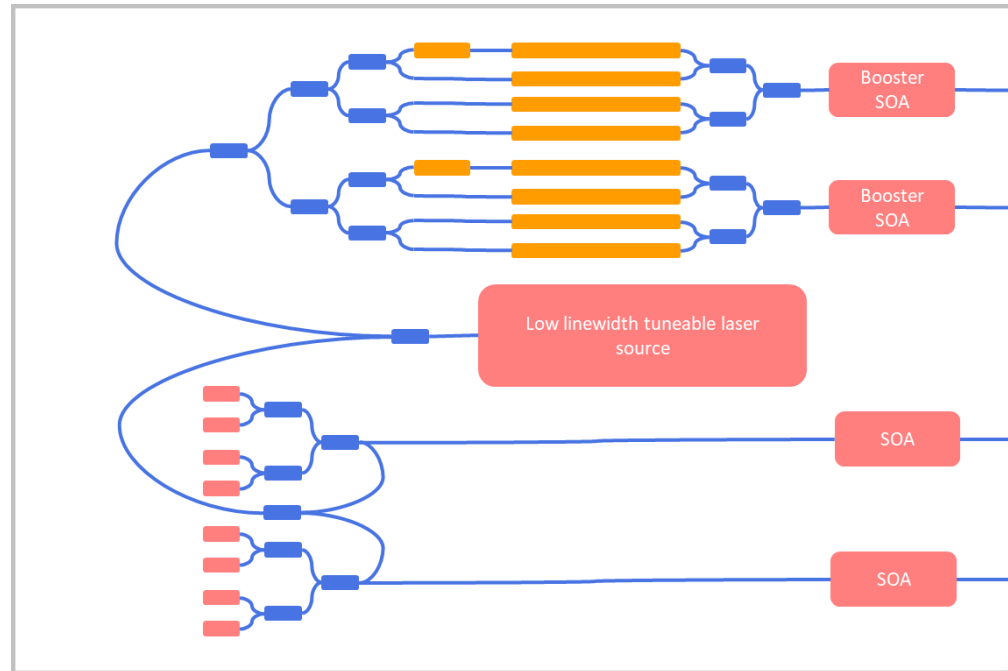
- Integrated modulator
- Monolithically Integratable with ITLA, SOA in the same process
- EO bandwidth > 70GHz
- MZI configuration tested up to 100Gbit 00K



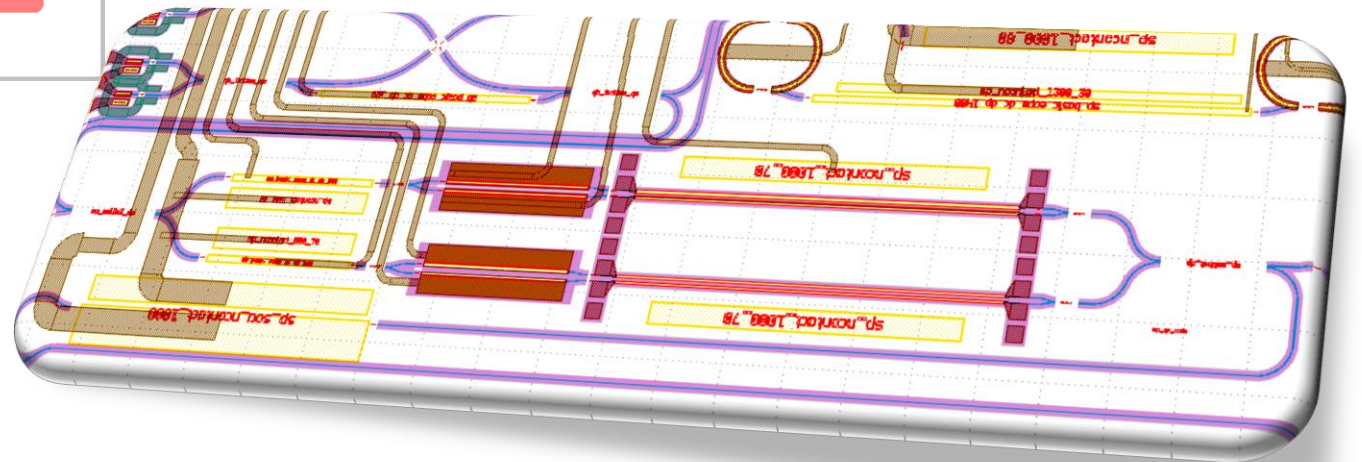
100 Gbaud

J. A. Hillier et al., OECC, 2023, pp. 1-3, doi: 10.1109/OECC56963.2023.10209945.

FULL COHERENT TXRX SYSTEM ON CHIP



- High speed IQ modulators
- Monolithically integrated narrow linewidth tuneable laser
- High speed photodiodes
- Integrated amplifiers
- High temperature operation



CONCLUSIONS



Coherent technology, QKD and LiDAR require complex PICs



InP PICs address cost, output power, footprint



Advanced PDKs offer fast time-to-market

Can a PDK-based InP Foundry respond to current market trends? - yes, but let's find out for you



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Bringing your innovation to life

Booth 5305

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